As an inventor named below or on any attached continuation page, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled SEMICONDUCTOR FUSES, METHODS OF USING THE SAME, METHODS OF MAKING THE SAME, AND SEMICONDUCTOR DEVICES CONTAINING THE SAME, the specification of which (check one):

is attached hereto.				
	United States application serial no.	and was amended on and was amended under PCT Article 19 on		
D was filed on as !	PCT international application no.	and was aniemed under PC1 Article 19 on	 '	
I hereby state that I have reviewed	and understand the contents of the above-	identified specification, including the claims, as amen	ded by any amendment	
referred to above.				
t administrator de la distrator d'autorio	es the 11 C. Detect and Tondomerk Office.	all information knows to me to be material to the sea		
	"materiality" is defined in Title 37, Code of	all information known to me to be material to the pate of Federal Regulations § 1.56.	intability of the subject	
certificate or § 365(a) of any PCT inte attached continuation page and have a	ernational application(s) designating at leas Iso identified below and on any attached co esignating at least one country other than t	§ 119(a)-(d) or § 365(b) of any foreign application(s) st one country other than the United States of America ontinuation page any foreign application for patent or the United States of America having a filing date befo	a listed below and on an inventor's certificate or	
Prior foreign/PCT application(s):			Priority Claimed	
(number)	(country)	(day/month/year filed)	Yes No	
(number)	(country)) (day/month/year filed)	Yes No	
		wn to me to be material to patentability as defined in application and the national or PCT international filin	g date of this application	
(-FF	((
(application serial no.)	(filing date)	(status - pending, patented or a	ibandoned)	
I hereby claim the	ne benefit under Title 35, United States Coo	de, § 119(e) of any United States provisional applicati	on(s) listed below:	
(provisional application no.)	(filing date)			
(provisional application no.)	(filing date)			
(provisional application no.)	(filing date)			
I hereby appoint the following Regionnected therewith:	stered Practitioners to prosecute this applica	ation and to transact all business in the Patent and Tra	idemark Office .	
David V. Trask, Reg. No. 22,012	William S. Britt, Reg. No. 20,9	969 Thomas J. Rossa, Reg. No. 26,799)	
Laurence B. Bond, Reg. No. 30,54				
Allen C. Turner, Reg. No. 33,041 Robert G. Winkle, Reg. No. 37,47	Kent S. Burningham, Reg. No. 4 Patrick McBride, Reg. No. 39,2			
Brick G. Power, Reg. No. 38,581	Kenneth C. Booth, Reg. No. P-		,31	
Michael L. Lynch, Reg. No. 30,87				
ddress all correspondence to:	Joseph A. Walkowski, telephone no. (80 TRASK, BRITT & ROSSA P.O. BOX 2550	11) 532-1922.		
	Salt Lake City, Utah 84110			
I hereby declare that all statements	made herein of my own knowledge are true	and that all statements made on information and belie	of are believed to be	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first joint inventor: Zhongze Wang Inventor's signature	26.1	1 Date	9/14/98
Residence: Boise, Idaho			, ,
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DECLARATION FOR PATENT APPLICATION (continuation page)

Invention title: SEMICONDUCTOR FUSES, METHODS OF USING THE SAME, METHODS OF MAKING THE SAME, AND SEMICONDUCTOR DEVICES CONTAINING THE SAME

Inventor name(s) appearing on first declaration page: Zhongze Wang

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Wang, et al

Serial No.: 09/165,754

Filed: October 2, 1998

For: SEMICONDUCTOR FUSES, METHODS OF USING THE SAME,

METHODS OF MAKING THE SAME, AND

SEMICONDUCTOR DEVICES CONTAINING THE SAME

Examiner: P. Luu

Group Art Unit: 2824

Attorney Docket No.: 3541US (97-855)

CERTIFICATE OF MAILING

I hereby certify that this paper or fee along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 31 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and is an envelope addressed to the Commissioner for Passats. Washington, D.C. 2003.

2/1/01 Dae of Deposit

nted name of person whose signature is

ASSOCIATE POWER OF ATTORNEY (37 C.F.R. § 1.34(b))

Commissioner for Patents Washington, D.C. 20231

In accordance with 37 C.F.R. § 1.34(b), please recognize the following individual as an Sir: associate agent/attorney herein in connection with the above-identified patent application, and with all continuing and divisional applications hereof:

Krista Weber Powell, Reg. No. P-47,867

Respectfully submitted,

Joseph A. Walkowski Registration No. 28,765 Attorney for Applicants

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Date: February 1, 20001 JAW/KWP/ps:djp N:\2269\3541\AssocPOA.wpd